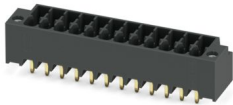


DMCV 1,5/12-G1F-3,5-LRP26AUTHR - PCB header



1874315
<https://www.phoenixcontact.com/us/products/1874315>

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PCB headers, nominal cross section: 1.5 mm², color: black, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Au, contact connection type: Pin, number of potentials: 24, number of rows: 2, number of positions: 12, number of connections: 24, product range: DMCV 1,5/-G1F-THR, pitch: 3.5 mm, mounting: THR soldering / wave soldering, pin layout: Linear pinning, solder pin [P]: 2.6 mm, number of solder pins per potential: 1, plug-in system: COMBICON DFMC 1,5, Pin connector pattern alignment: Standard, locking: Lock-and-release locking system, mounting method: Lock & Release, type of packaging: packed in cardboard

Your advantages

- Designed for integration into the SMT process
- Vertical connection enables multi-row arrangement on the PCB
- Screwable flange for superior mechanical stability
- Gold-plated contacts ensure transfer quality remains stable over the long term

Commercial data

Item number	1874315
Packing unit	50 pc
Minimum order quantity	50 pc
Product key	AABTJC
GTIN	4055626260150
Weight per piece (including packing)	5.418 g
Weight per piece (excluding packing)	5.26 g
Country of origin	DE

Technical data

Product properties

Product type	PCB headers
Product family	DMCV 1,5/..-G1F-THR
Product line	COMBICON Connectors S
Type	Headers
Number of positions	12
Pitch	3.5 mm
Number of connections	24
Number of rows	2
Number of potentials	24
Pin layout	Linear pinning
Solder pins per potential	1

Electrical properties

Properties

Nominal current I_N	8 A
Nominal voltage U_N	160 V
Contact resistance	1.9 mΩ
Rated voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	250 V
Rated surge voltage (II/2)	2.5 kV

Mounting

Mounting type	THR soldering / wave soldering
Pin layout	Linear pinning

Flange

Tightening torque	0.2 Nm
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Processing notes

Process	Reflow/wave soldering
Moisture Sensitive Level	MSL 1
Classification temperature T_c	260 °C
Solder cycles in the reflow	3

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
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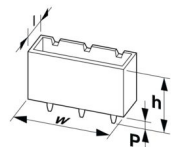
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Contact material	Cu alloy
Surface characteristics	partially gold-plated
Metal surface contact area (top layer)	Gold (0.8 - 1.4 μm Au)
Metal surface contact area (middle layer)	Nickel (2 - 4 μm Ni)
Metal surface soldering area (top layer)	Tin (3 - 5 μm Sn)
Metal surface soldering area (middle layer)	Nickel (2 - 4 μm Ni)

Material data - housing

Color (Housing)	black (9005)
Insulating material	LCP
Insulating material group	IIIa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Dimensions

Dimensional drawing	
Pitch	3.5 mm
Width [w]	49 mm
Height [h]	12.6 mm
Length [l]	10.6 mm
Installed height	10 mm
Solder pin length [P]	2.6 mm
Pin dimensions	0.8 x 0.8 mm

PCB design

Pin spacing	5.50 mm
Hole diameter	1.4 mm

Mechanical tests

Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

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Polarization and coding

Specification	IEC 60512-13-5:2006-02
Result	Test passed

Contact holder in insert

Specification	IEC 60512-15-1:2008-05
Contact holder in insert Requirements >20 N	Test passed

Insertion and withdrawal forces

Result	Test passed
No. of cycles	100
Insertion strength per pos. approx.	2 N
Withdraw strength per pos. approx.	1 N

Electrical tests

Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	15

Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	IIIa
Comparative tracking index (IEC 60112)	CTI 175
Rated insulation voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	2.5 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.6 mm
Rated insulation voltage (II/2)	250 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	2.5 mm

Environmental and real-life conditions

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 500 - 10 Hz

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Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 500 Hz)
Test duration per axis	2 h
Test directions	X-, Y- and Z-axis

Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	2.95 kV
Contact resistance R_1	1.9 m Ω
Contact resistance R_2	2.1 m Ω
Insertion/withdrawal cycles	100
Insulation resistance, neighboring positions	> 5 M Ω

Climatic test

Specification	DIN 50018:2013-05
Corrosive stress	1.0 dm ³ SO ₂ on 300 dm ³ /40 °C/1 cycle
Thermal stress	100 °C/168 h
Power-frequency withstand voltage	1.39 kV

Shocks

Specification	IEC 60068-2-27:2008-02
Pulse shape	Semi-sinusoidal
Acceleration	30g
Shock duration	18 ms
Test directions	X-, Y- and Z-axis (pos. and neg.)

Ambient conditions

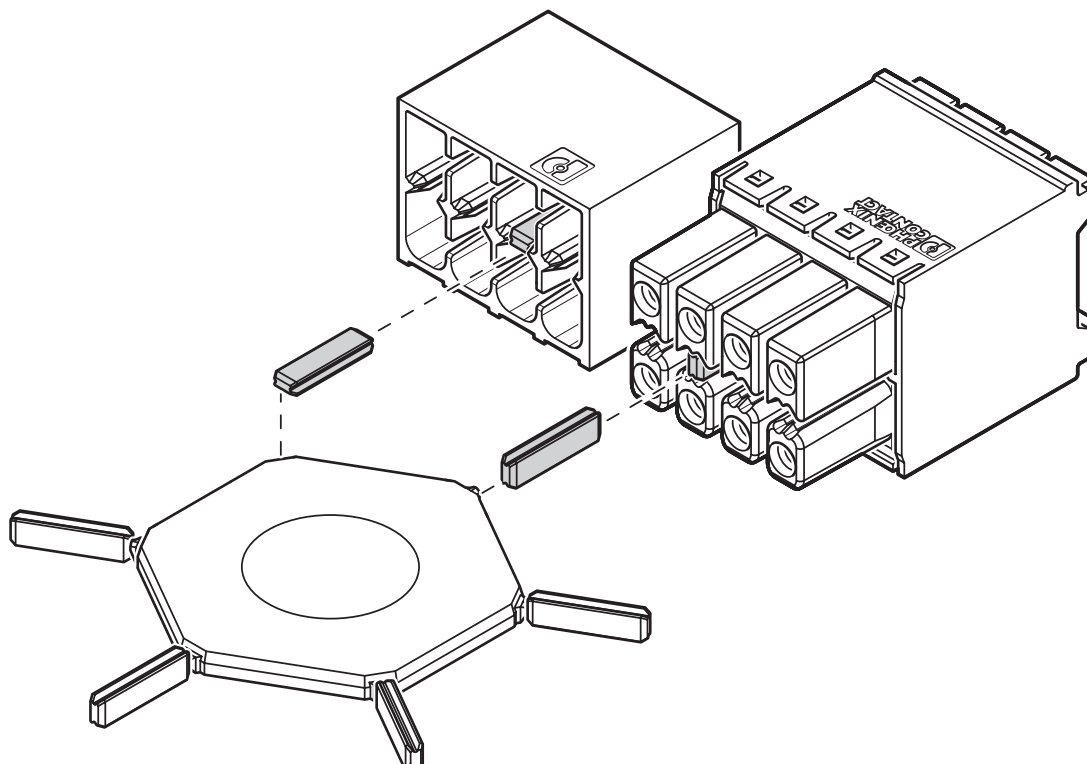
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)
Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C

Packaging specifications

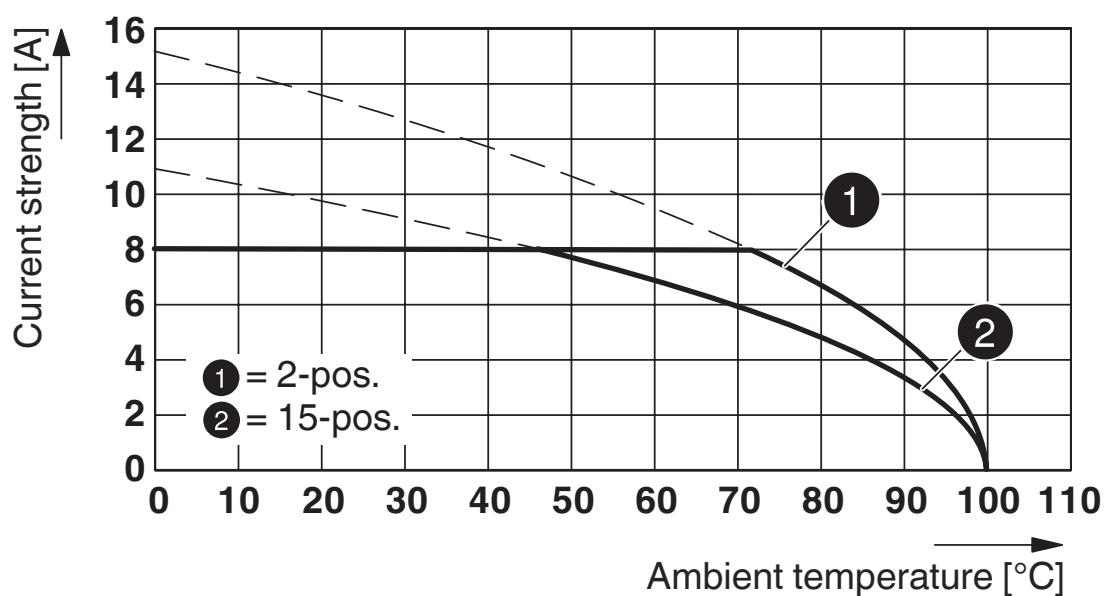
Type of packaging	packed in cardboard
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Drawings

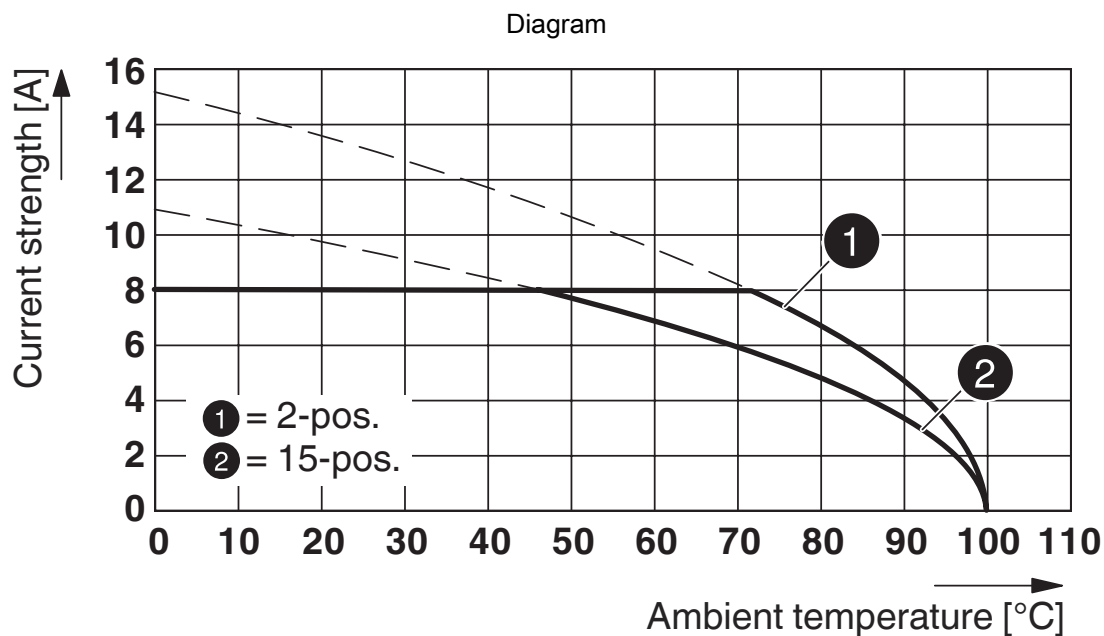
Schematic diagram



Diagram

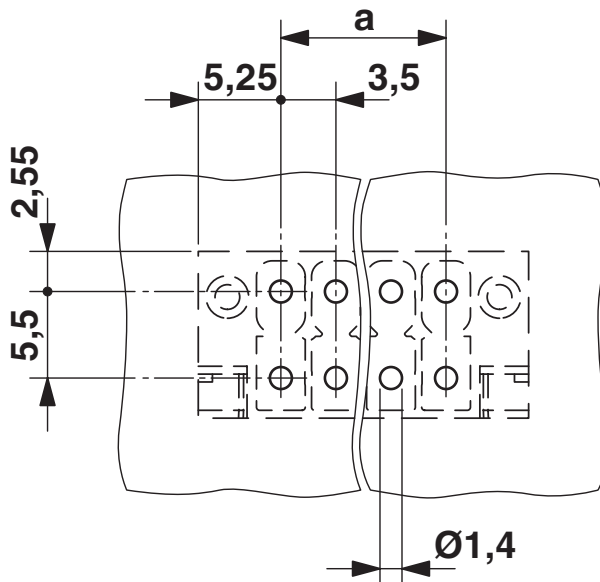


Type: DFMC 1,5/...-STF-3,5 BK AU with DMCV 1,5/...-G1F-3,5-LRAUP20THR



Type: DFMC 1,5/...-ST-3,5-LR AU with DMCV 1,5/...-G1F-3,5-LRAUP...THR

Drilling plan/solder pad geometry



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Approvals

To download certificates, visit the product detail page: <https://www.phoenixcontact.com/us/products/1874315>

 cULus Recognized Approval ID: E60425-20110128				
	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
B	300 V	8 A	-	-
C	50 V	8 A	-	-
D	300 V	8 A	-	-

 VDE report with production monitoring Approval ID: 40038423				
	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
keine	160 V	8 A	-	-

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Classifications

ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

ETIM

ETIM 9.0	EC002637
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UNSPSC

UNSPSC 21.0	39121400
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Environmental product compliance

EU RoHS	
Fulfills EU RoHS substance requirements	Yes, No exemptions
China RoHS	
Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits
EU REACH SVHC	
REACH candidate substance (CAS No.)	No substance above 0.1 wt%